

Attorney Docket No. 110348-135118

Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Application of:

RamachandraRao, et al.

Application No.: 10/814,498

Filed: March 31, 2004

Confirmation No.: 6442

For: WAFER STACKING USING
INTERCONNECT STRUCTURES
OF SUBSTANTIALLY UNIFORM
HEIGHT

Examiner: Lee, Calvin

Group Art Unit: 2818

Customer No.: 25,943

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AMENDMENT AND RESPONSE TO FINAL OFFICE ACTION

To The Commissioner for Patents:

INTRODUCTORY COMMENTS

This paper is in response to the final Office Action dated July 21, 2005. The shortened period for response extends to October 21, 2005. Claims 1-3 and 15-25 remain pending in the application. Claims 1-3 and 15-25 have been rejected by the Examiner. Consideration of the above-captioned application is respectfully requested in view of the amendments as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are in the listing of claims on page 3 of this paper.

Remarks/Arguments begin on page 8 of this paper.

IPG No. P17262

SEA/110348/135118/KHF/341916.1

OK TO ENTER
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